SLG51003V-EVB

SLG51003V Power GreenPAK Evaluation Board R1.2

SLG51003V Evaluation Board (EVB) provides programming, emulation, and testing functions for the SLG51003V IC. Working in pair with the Go Configure™ Software Hub it can be used as:

- standalone board
- with the Power GreenPAK Development Motherboard
- with the GreenPAK Serial Debugger

Features

- LDO input and output connectors with Kelvin sense
- RF connectors for each LDO input and output channel
- GPIO connector
- GreenPAK Serial Debugger connector for quick debugging

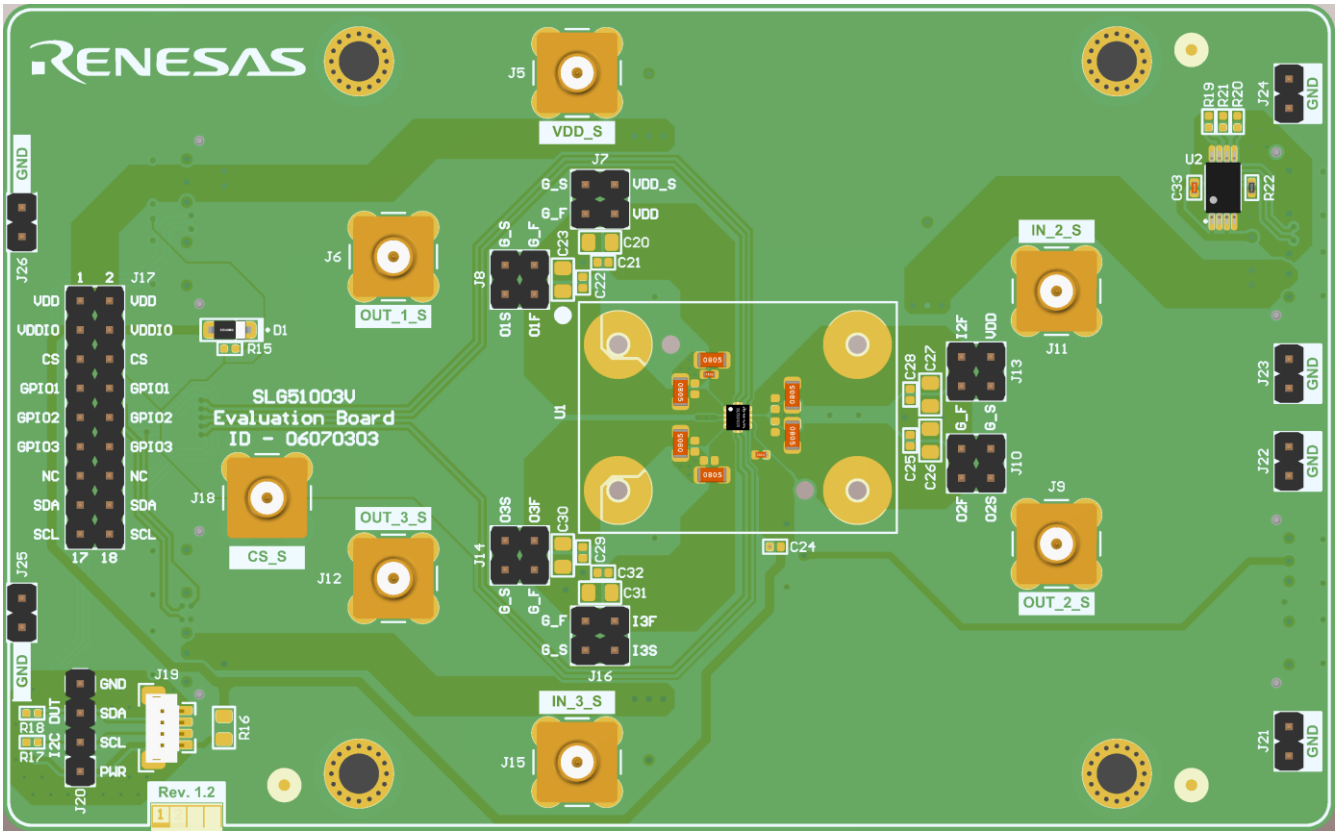


Figure 1. SLG51003V Evaluation Board

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1. Functional Description

SLG51003V Evaluation Board provides connection between an IC and the following two devices for programming, emulation, and testing functions:

- Power GreenPAK Development Motherboard (PGP_DM)
- GreenPAK Serial Debugger (GSD).

This Evaluation Board can be used to apply the Power GreenPAK IC to the custom design with a minimum of additional tools. The Evaluation Board has the following connectors, shown in Figure 2 and Figure 3:

- Input Force (power) pins for LDO channels of the SLG51003V
- Output Force (power) pins for LDO channels of the SLG51003V
- Input Sense (Kelvin) pins for input voltage measurements
- Output Sense (Kelvin) pins for output voltage measurements
- Connector for GPIO signals
- Connector for the GreenPAK Serial Debugger
- Several ground pins distributed across the board.

Figure 2 shows the main points to connect supply voltage to LDOs, LDOs output load, GPIO signals, and GSD connector. Figure 3 shows the points for more accurate measurements using SMB connectors.

Input Force pins are designed to provide input voltage to the LDO.

Output Force pins are designed for connection to the load, external circuit, and others.

Pin headers have power lines marked with the "F" suffix. For example, for positive power lines there are "VDD" – force line for the V_{DD} pin, "I2F" – force line for the input channel 2, "O2F" – force line for the output channel 2, while for negative power lines there is "G_F" – force line for ground.

The Evaluation Board can be connected to the main Development Motherboard or directly by the pin headers. The first option is standard for users and does not require any board modifications. The second option allows to shorten the path from the source/sink connected to the pin headers to the device under test (DUT) IC. This connection can be used for more accurate parameters testing of the DUT IC, such as Power Supply Rejection Ratio (PSRR), transient response, and others, but for this option, the board should be slightly modified.

Input/Output Sense pins are designed for precise voltage measurements and to eliminate voltage drop caused by the load current across the PCB polygons, between the connector pins and the IC pads. Also, they can be used as a voltage sense for more accurate voltage control near the SLG51003V. They are marked on the board with the "S" suffix. For example, "VDD_S", 'I2S', "O2S" – for positive sense lines and "G_S" – for negative sense lines. It is important to connect only the measuring equipment to these pins that consumes low current, otherwise, by connecting high load current, these signal lines may burn out.

GPIO signals connector is designed for interacting with external circuits, make external pull-up or pull-down pin function, inject signals, and others.

GreenPAK Serial Debugger connector is designed to connect the GSD board that allows to emulate the IC through the Go Configure™ Software Hub for further custom design evaluation. This is a “light” version of the tool to interact with the IC. The more advanced tool is the Power GreenPAK Development Motherboard. Connectors for the PGP_DM are located on the bottom side of the Evaluation Board and not shown in Figure 1.

Ground pins are located across PCB and designed for convenient signal connections to the board.

Board limitations are determined by the SLG51003V. Recommended input voltage range for LDO channels and GPIO inputs are described in Table 1.

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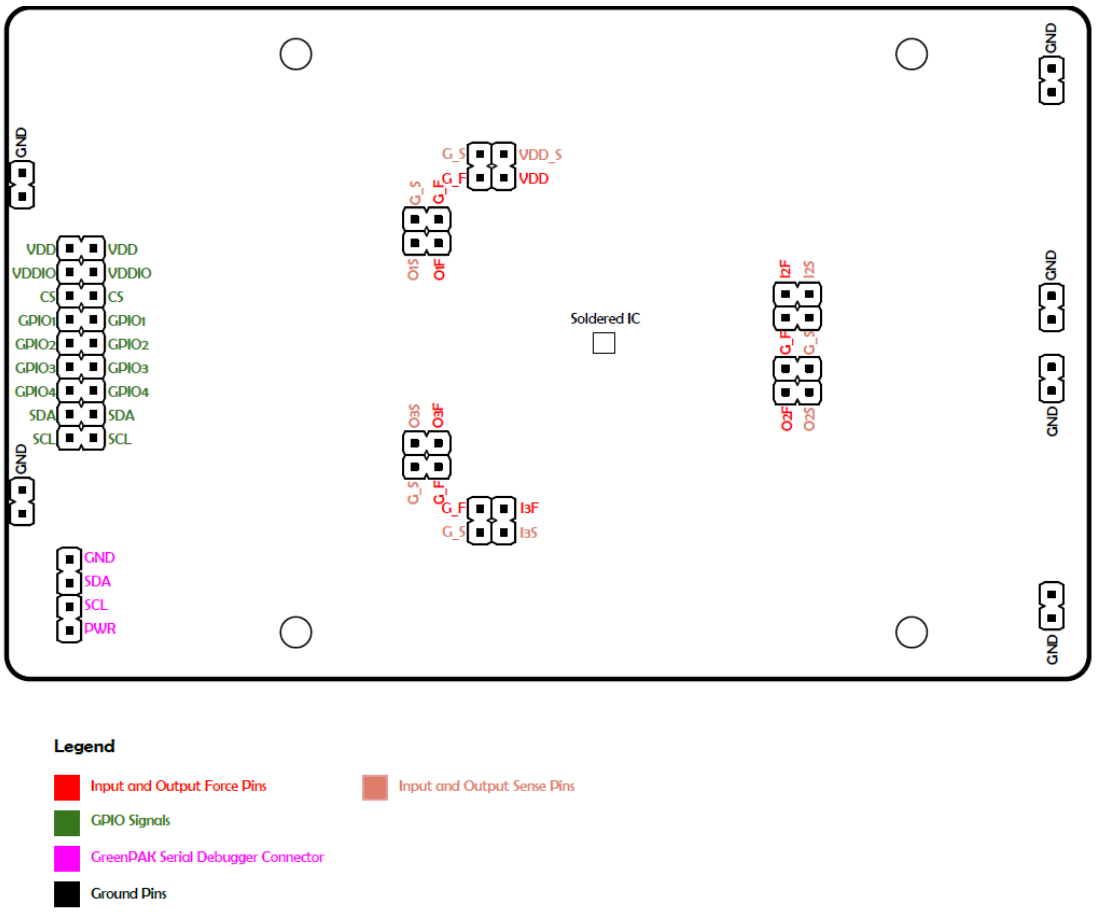


Figure 2. Pin Location of LDO Input/Output with Kelvin Functions Pins, GPIO Pins, GSD Connector on Evaluation Board

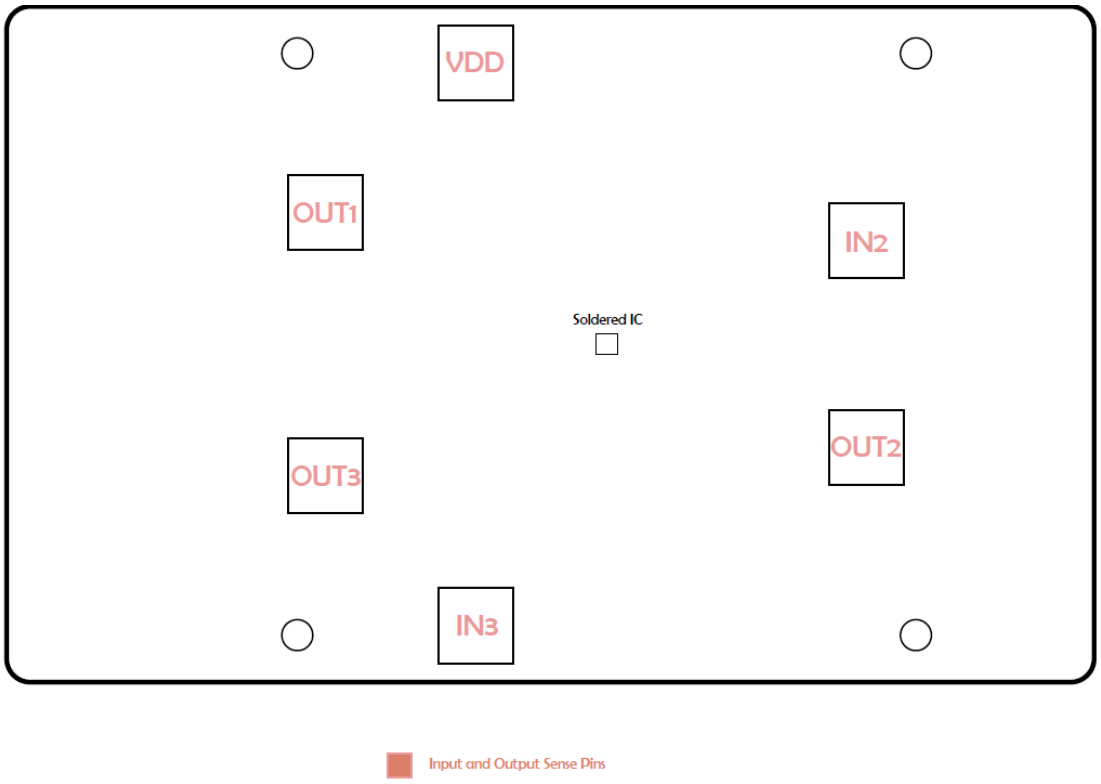


Figure 3. Pin Location of SMB Measurement Connectors on Evaluation Board

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Table 1. Recommended Operating Conditions

Parameter		Min	Max	Unit
Power Supply Voltage on V_{DD} Pin		2.8	5.0	V
Power Supply Voltage on V_{DDIO} Pin		1.2	V_{DD}	V
Power Supply Voltage on V_{IN2} Pin		1.7	5.0	V
Power Supply Voltage on V_{IN3} Pin	LDO Mode	0.8	1.5	V
	Load Switch Mode	0.5	1.4	V
Voltage on GPIO4_SDA and GPI5_SCL Pins		0	V_{DDIO}	V
Voltage on GPIO1 to GPIO3 Pins		-0.3	V_{DDIO}	V
Voltage on CS Pin		-0.3	V_{DD}	V
Operating Ambient Temperature Range		-40	+85	°C

Figure 4 demonstrates connections between connectors and LDO channels of the IC. Sense lines (also, connectors) are designed only for the measurement equipment and cannot be used for power distribution. Otherwise, Kelvin functions may burn out on the PCB and the Evaluation Board will be damaged and inoperable.

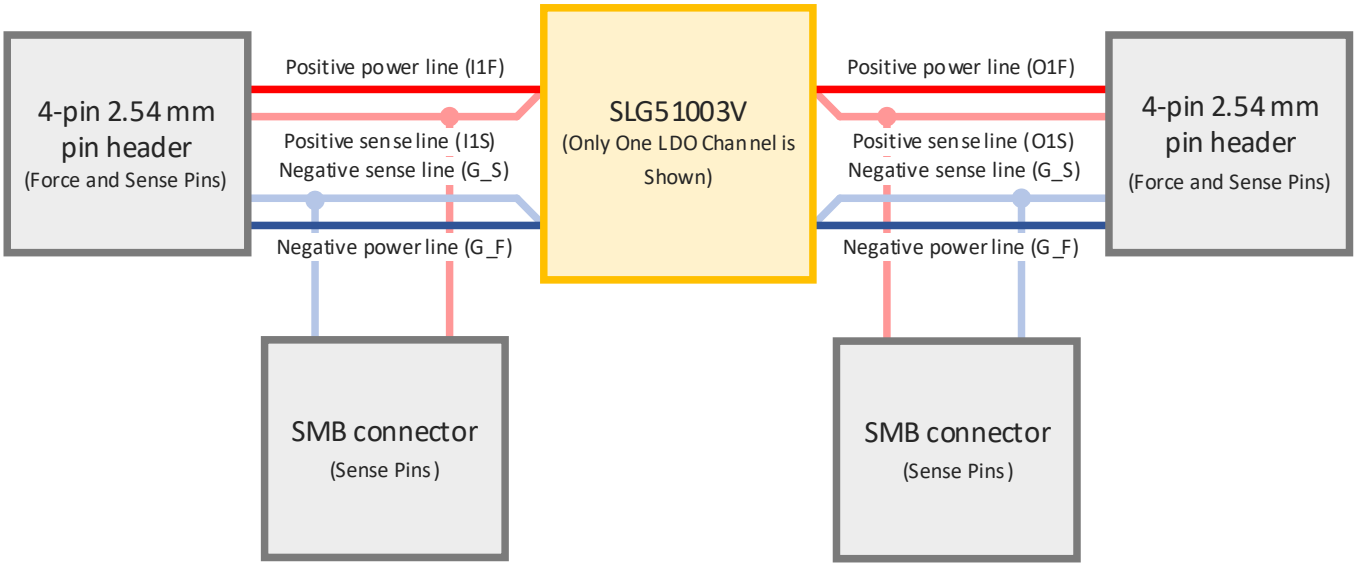


Figure 4. Input/Output Force LDO Pins with Kelvin Functions

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2. Working with the SLG51003V Evaluation Board

2.1 Using GreenPAK Serial Debugger with Evaluation Board

To start using the Evaluation Board for chip emulation, three separate power supplies are required alongside with the GreenPAK Serial Debugger. For IC emulation, apply V_{DD} and V_{DDIO} based on application requirements and 1.8 V to the chip select (CS) pin, then insert the GSD board as shown in Figure 5. A typical connection circuit for chip emulation is shown in Figure 6.

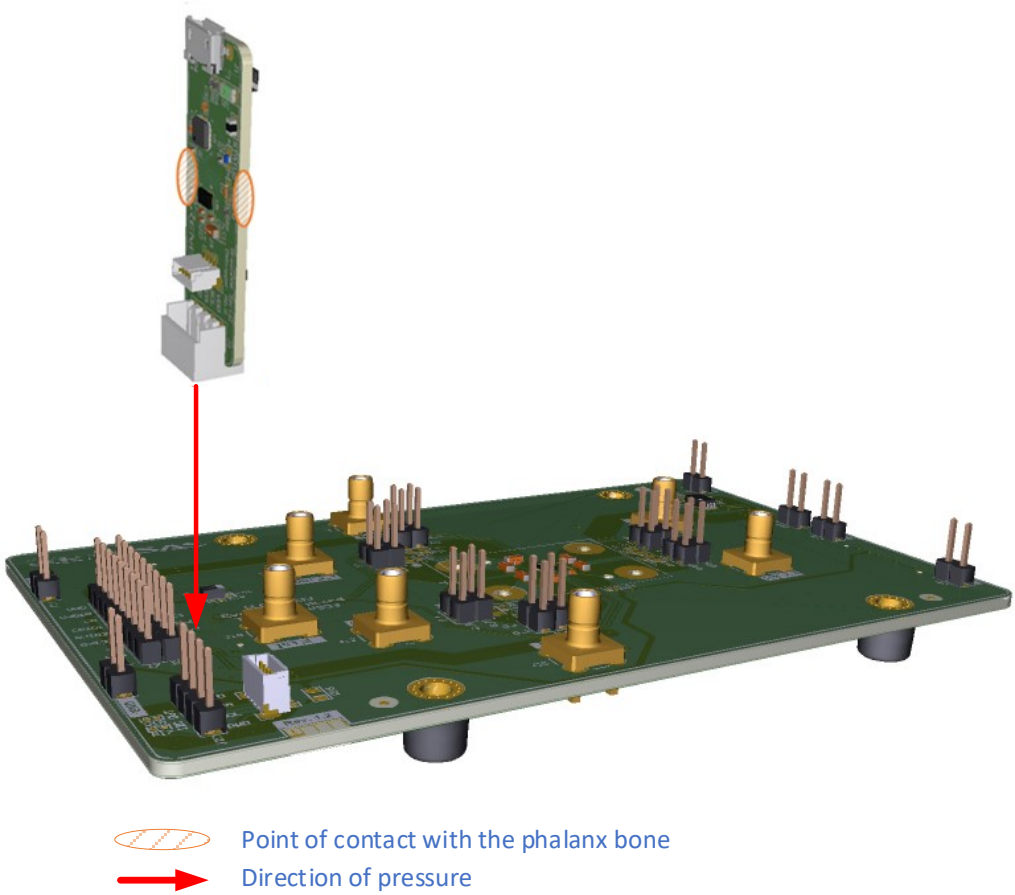


Figure 5. Connecting GSD Board to Evaluation Board

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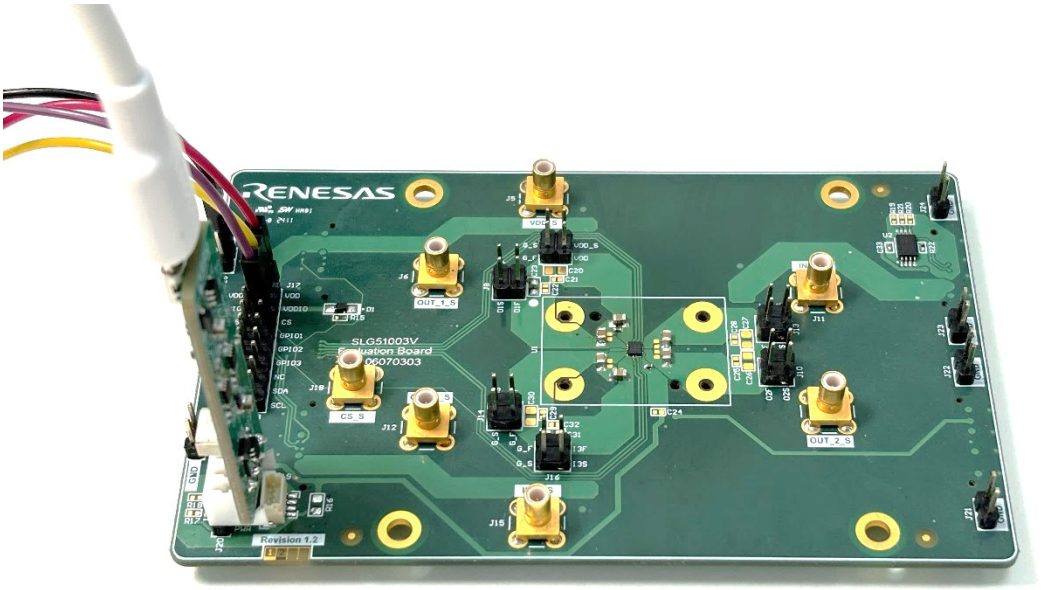


Figure 6. Evaluation Board with GreenPAK Serial Debugger

Figure 8 shows debugging control setup for working with GSD. The programming feature for OTP devices is not available using GSD tool. I²C levels must be within the allowed range, shown in Table 2, that corresponds to one of the configured settings in Go Configure™ Software Hub, as shown in Figure 7.

Table 2. Brief I²C Specification

Symbol	Description	Conditions	Min	Typ	Max	Unit
V_{IH}	HIGH level input voltage	I²C mode: V_{DDBUS} = 1.2 V[1]	0.7 * V_{DDBUS}	--	--	V
V_{IL}	LOW level input voltage	--	--	--	0.3 * V_{DDBUS}	V
[1] V_{DDBUS} defines the voltage level for I²C pins (GPIO4_SDA, GPI5_SCL) in Go Configure™ Software Hub and, depends on the actual V_{DDIO} level, should be set as 1.2 V for 1.2 V ≤ V_{DDIO} ≤ 1.5 V or 5 V for 1.8 V ≤ V_{DDIO} ≤ 5 V.						

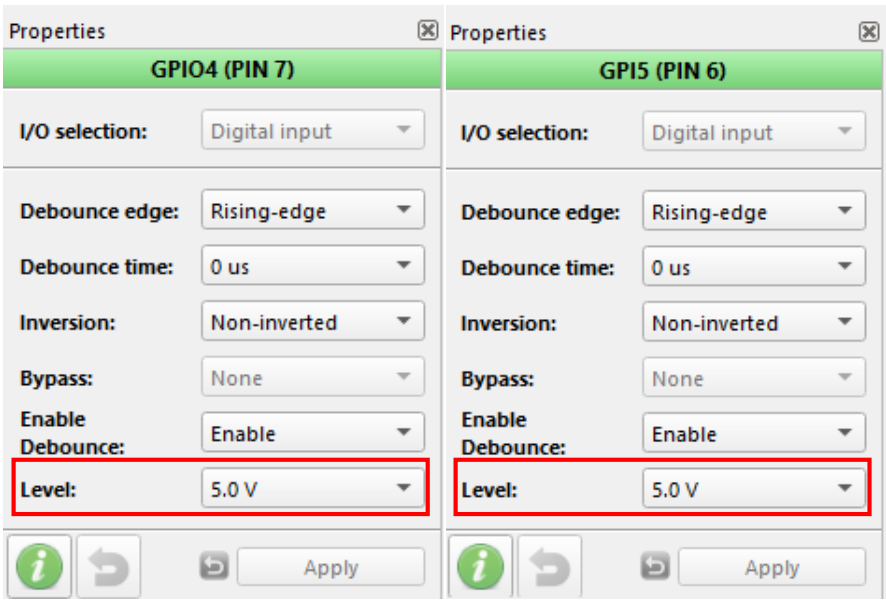


Figure 7. V_{DDBUS} Level Settings for I²C in Go Configure™ Software Hub

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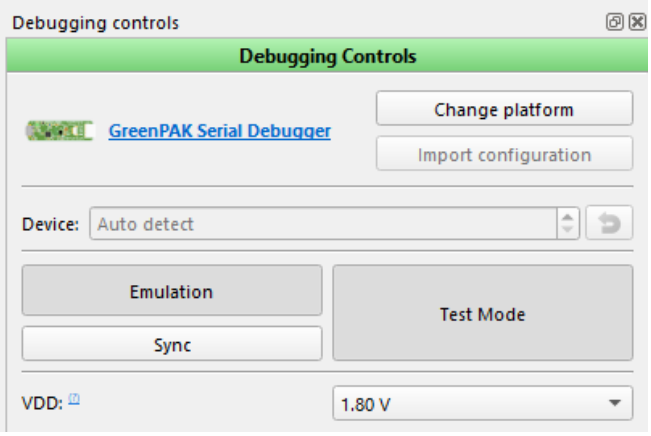


Figure 8. GSD Debugging Setup

2.2 Precise Measurements Using Evaluation Board

As mentioned above, precise measurements, such as PSRR, transient response, and others, can be performed on this board. This is not a typical use case for the evaluation and requires minor modifications to the PCB components position. Figure 9 shows default placement of the board components.

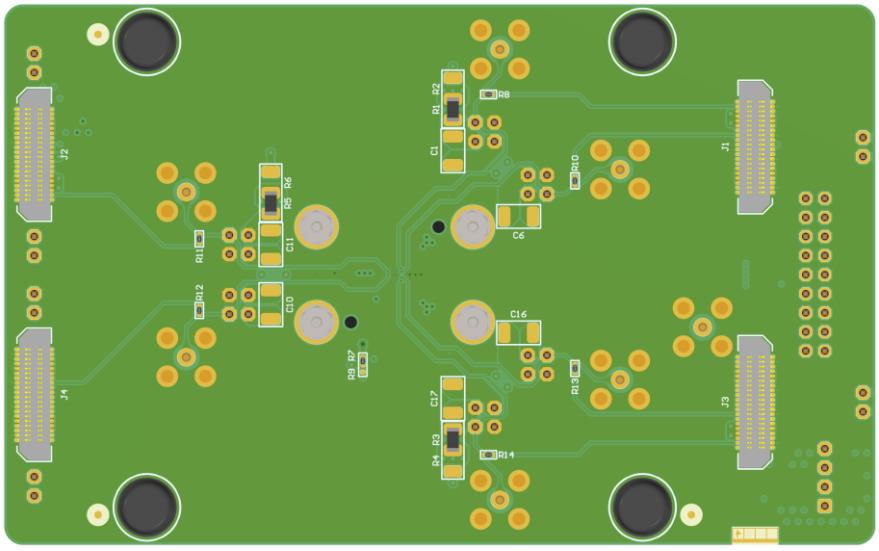


Figure 9. Bottom Side of the Evaluation Board

The main idea is to shorten the path from the connectors to the IC and disable unused connectors, polygons, and traces. To do so, it is necessary to change the position for below resistors:

- R1 -> R2 (V_{DD} line from the PGP_DM)
- R5 -> R6 (V_{IN2} line from the PGP_DM)
- R3 -> R4 (V_{IN3} line from the PGP_DM)
- R7 -> R9 (V_{DDIO} line from the PGP_DM).

To electrically disconnect the PGP_DM connector traces, remove R8, R10-R14.

Note: The PGP_DM connector traces automatically measure voltage at INs/OUTs of the DUT IC.

This operation will electrically disconnect the Motherboard main connectors and shorten the polygon lengths.

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2.3 Power GreenPAK Development Motherboard

As was previously stated, the Evaluation Board can be used in pair with the Power GreenPAK Development Motherboard, as shown in Figure 10. There are two revisions of such board – R1.0 and R1.1. Further description will be referred to R1.0.

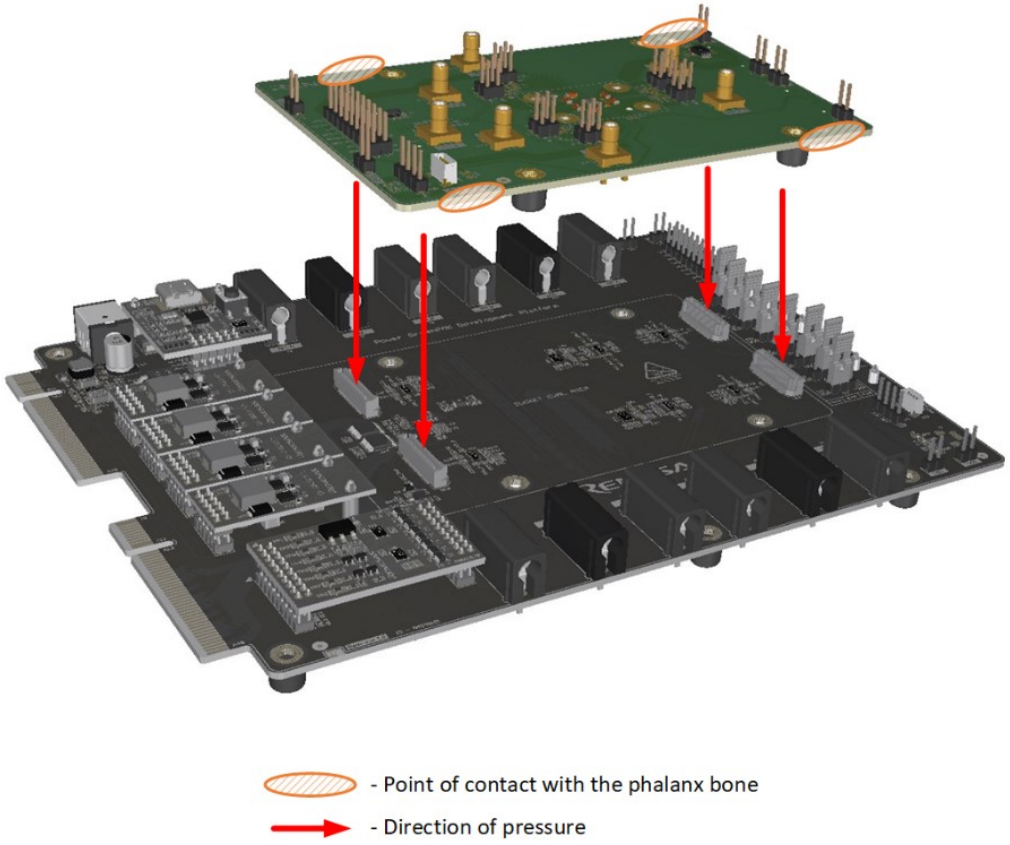


Figure 10. Inserting Evaluation Board on PGP_DM

To start using the PGP_DM, the user must have all items listed below:

- AC/DC power adapter
- USB cable
- Evaluation Board.

When all items above are available, follow the next steps:

1. Connect the AC/DC power adapter to the Motherboard (the sequence of connecting the AC and DC cables does not matter).
2. Connect the USB connector to the PC and the Motherboard (the sequence of connecting the PC and the Motherboard does not matter).
3. Open the software Go Configure™ Software Hub on the PC and start building the project. The software can be downloaded here.

When all connections are correct, “POWER” and “STATUS” LEDs on the USB Serial Module should be ON (static), D2 LED on the Motherboard and TP5, TP6, TP8 (in PGP_DM_R1.1 renamed to CS) LEDs on the GPIO Module should also be ON. The location of these LEDs is shown in Figure 11.

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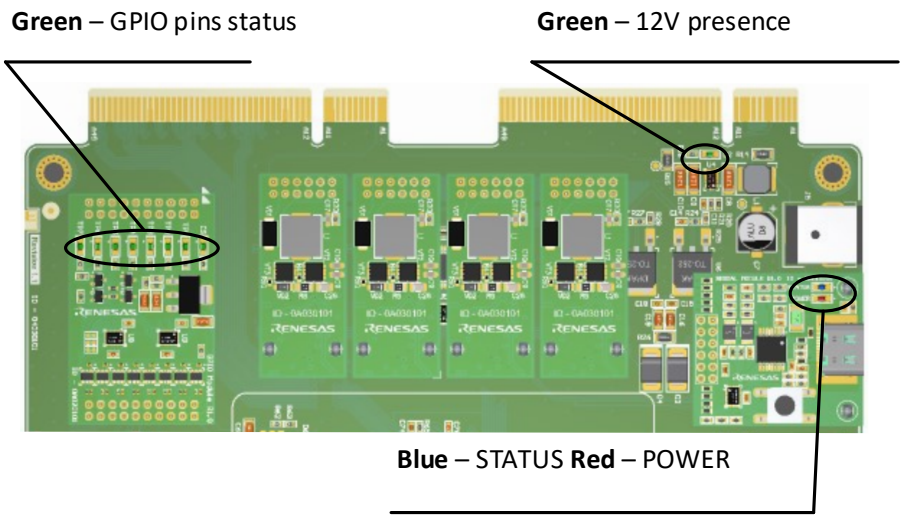


Figure 11. LEDs Location on PGP_DM

To emulate and program the IC, the Evaluation Board should be inserted in the PGP_DM. To do so, find the evaluation board area on the PGP_DM, as shown in Figure 12, and connect the Evaluation Board to the PGP_DM through the J18-J21, DC1-DC4 connectors, highlighted in red.

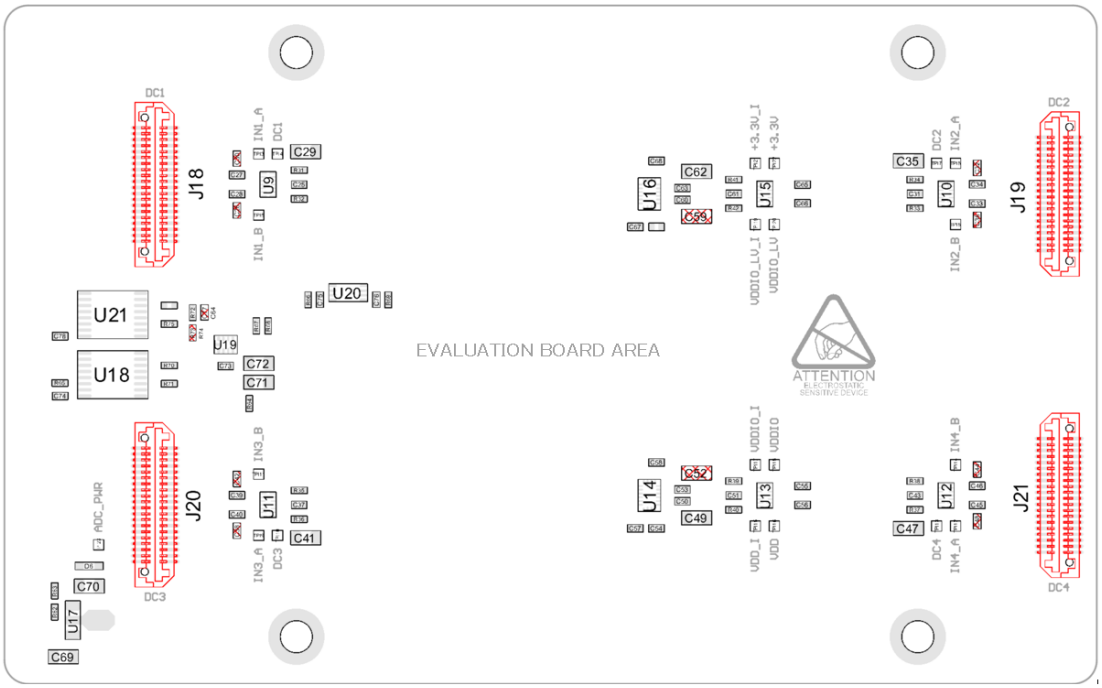


Figure 12. Evaluation Board Area on the PGP_DM

Figure 13 shows debugging control setup for working with the PGP_DM. Programming option for OTP devices is available only when using the PGP_DM.

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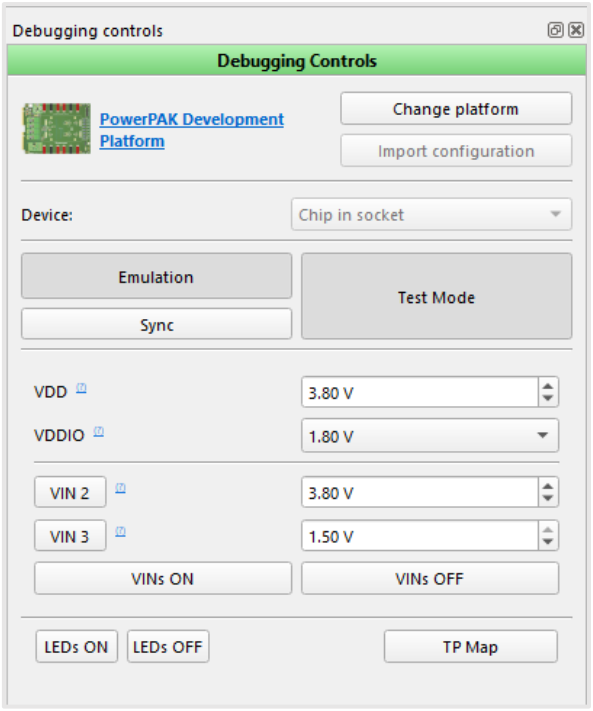


Figure 13. PGP_DM Debugging Setup

LED state indication feature is available for all TPs, GPIO pull-up, pull-down, push-pull. TPs are connected to the GPIO IC pins of the installed Evaluation Board. Correspondence of TPs to the GPIO ports can be checked in the design by clicking the TP Map button shown in Figure 13.

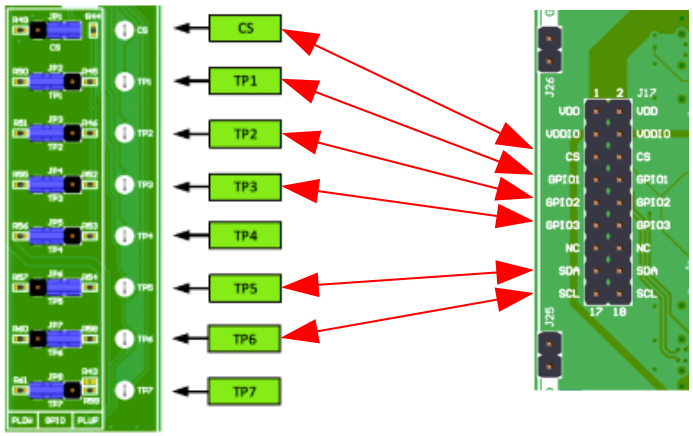


Figure 14. PGP_DM and SLG51003V-EVB GPIO Connector Pinout Correspondence

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3. Ordering Information

Part Number	Description
SLG51003V-EVB	SLG51003V Power GreenPAK Evaluation Board R1.2

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4. Revision History

Revision	Date	Description
1.01	Oct 17, 2024	Change details: • Replaced Figures 1, 5, 6 to show the latest EVB revision from 1.1 to 1.2 and name from SLG51003C Socket Eval to SLG51003V Evaluation Board. • Replaced Figure 12 to show the latest Evaluation Board Area name on the PGP_DM. • Changed the mentions of board revision from 1.1 to 1.2 in the whole document. • Updated Figure 15 because of changed C3 value in revision 1.2 from 0.1 µF to 10 nF. • Updated A.2 BOM section by changing C3 capacitor in revision 1.2 from 0.1 µF 16 V X7R 0402 to 10 nF 50 V X7R 0402. Added U2 BR24T02FV-WGE2 item. • Added Figure 18.
1.00	Aug 12, 2024	Initial release

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A. Evaluation Board Documentation

A.1 Schematic

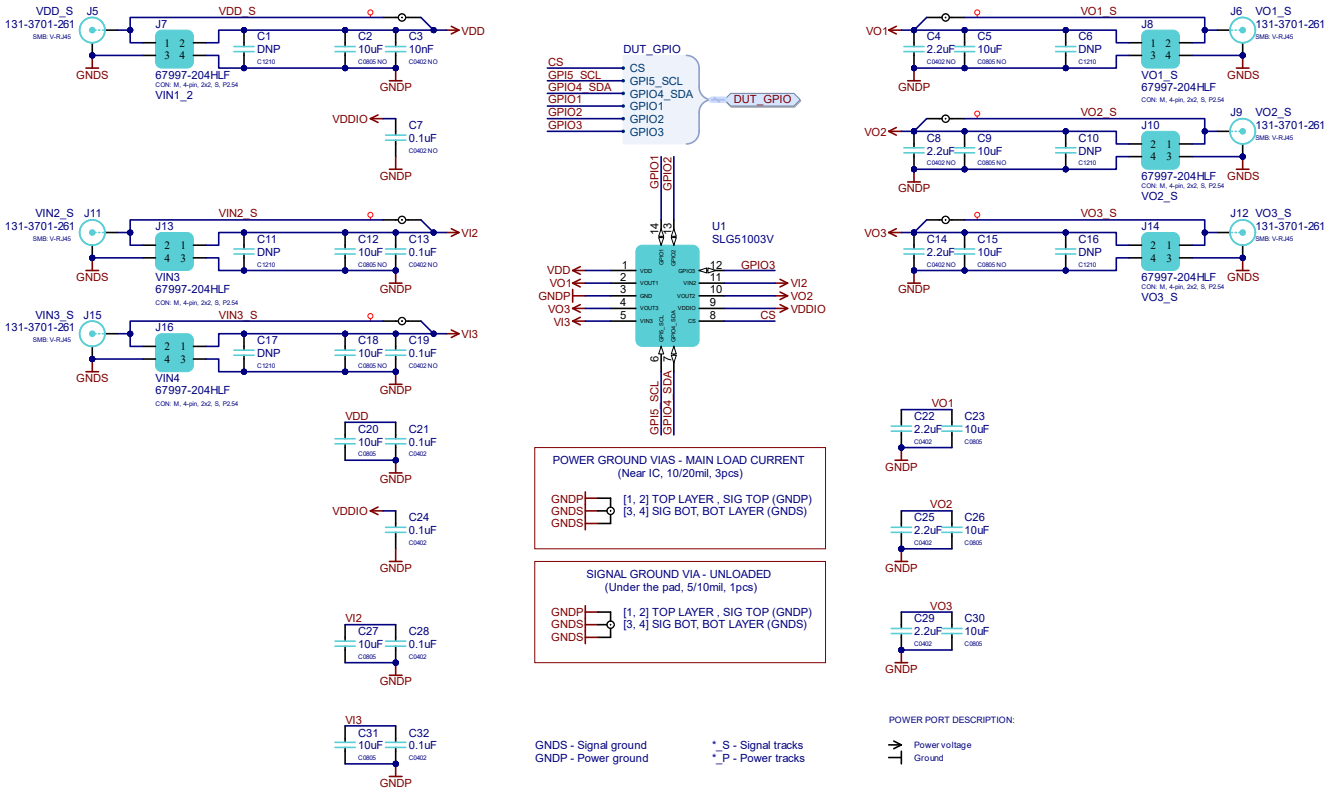


Figure 15. SLG51003V Evaluation Board - Power Section Schematic

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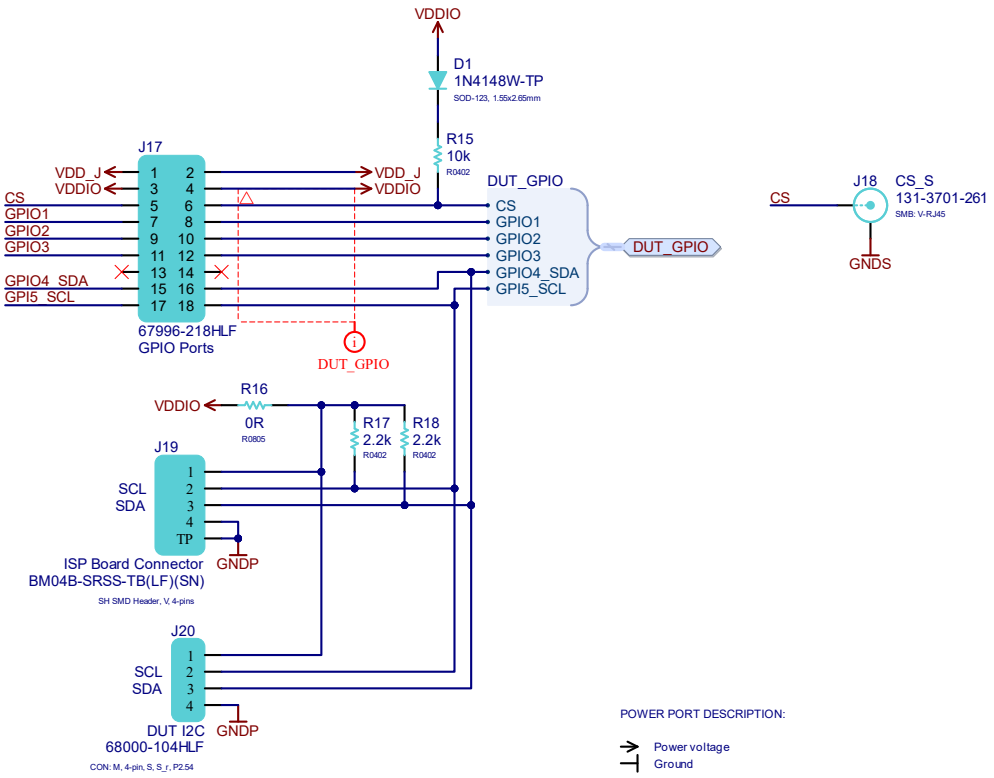


Figure 16. SLG51003V Evaluation Board - GPIO Section Schematic

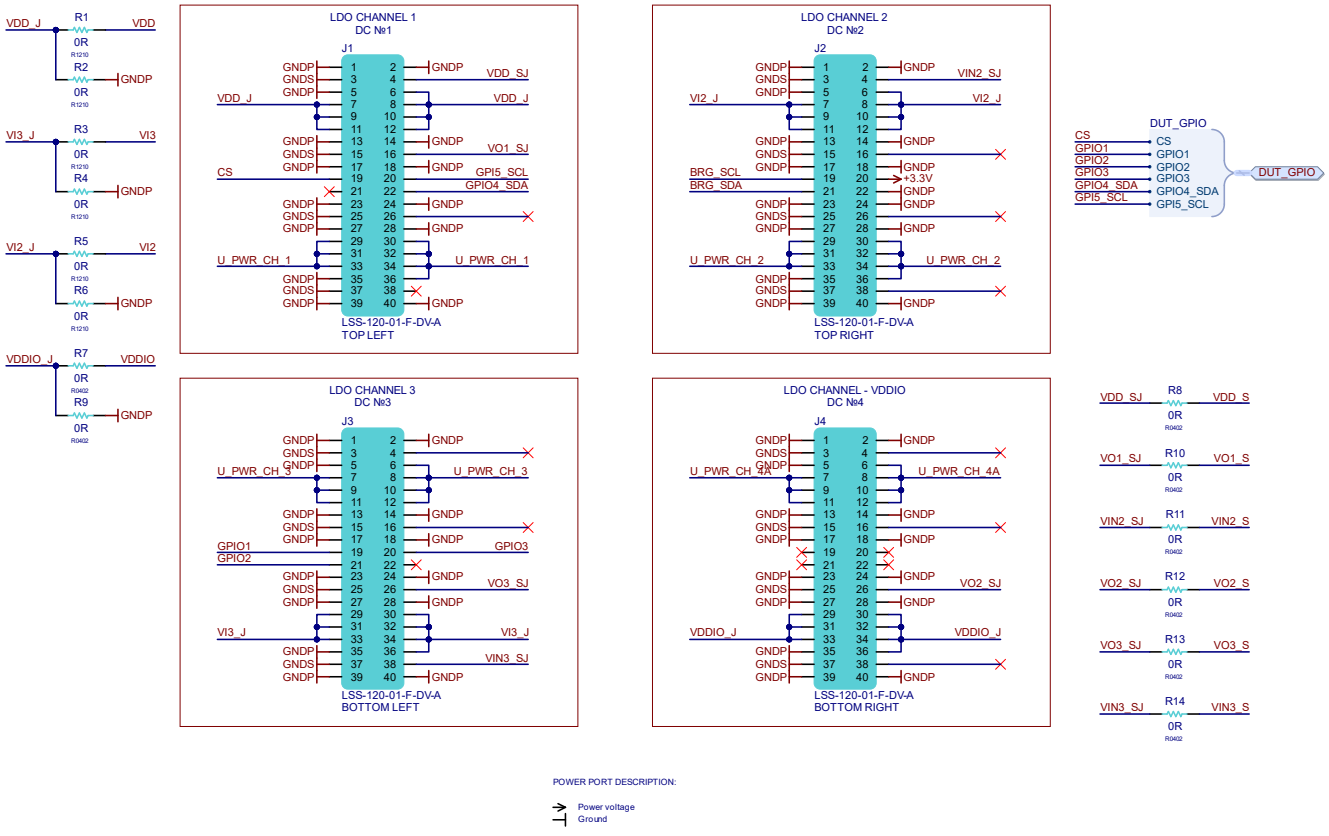


Figure 17. Connectors on the Bottom Layer for Connecting EVB to PGP_DM

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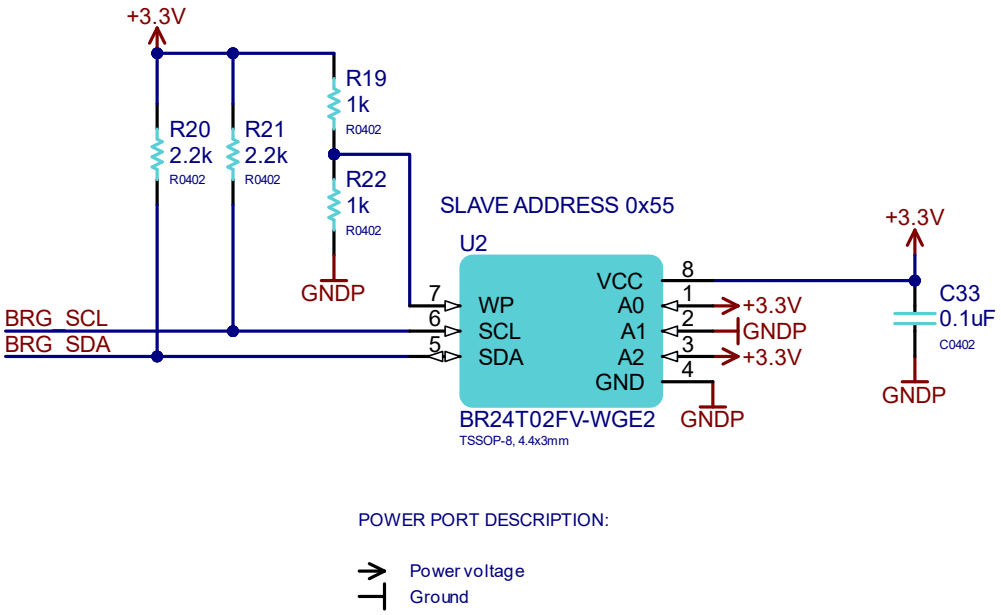


Figure 18. Board ID

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A.2 BOM

#	Items	Package	Quantity per Development Board	Symbol
1	SJ61A6	Bumper: perforated hole D3.5 mm	4	BP1, BP2, BP3, BP4
2	10 µF 16V X5R 0805	C0805 NO	6	C2, C5, C9, C12, C15, C18
3	10nF 50V X7R 0402	C0402 NO	1	C3
4	0.1 µF 16V X7R 0402	C0402 NO, C0402	3	C7, C33
5	1N4148W-TP	SOD-123, 1.55 mm x 2.65 mm	1	D1
6	LSS-120-01-F-DV-A	LSS-120-01-F-DV-A	4	J1, J2, J3, J4
7	131-3701-261	SMB: V-RJ45	7	J5, J6, J9, J11, J12, J15, J18
8	67997-204HLF	CON: M, 4-pin, 2x2, S, P2.54	6	J7, J8, J10, J13, J14, J16
9	67996-218HLF	CON: M, 18-pin, 9x2, P2.54	1	J17
10	BM04B-SRSS-TB(LF)(SN)	SH SMD Header, V, 4-pins	1	J19
11	68000-104HLF	CON: M, 4-pin, S, S_r, P2.54	1	J20
12	68000-102HLF	CON: M, 2-pin, S, S_r, P2.54d	6	J21, J22, J23, J24, J25, J26
13	0R 1210	R1210	3	R1, R3, R5
14	0R 0402	R0402	7	R7, R8, R10, R11, R12, R13, R14
15	1k 0402	R0402	1	R22
16	SLG51003V	14-pin TQFN: 2.0 mm x 2.2 mm x 0.55 mm	1	U1
17	BR24T02FV-WGE2	TSSOP-8, 4.4x3mm	1	U2

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